

2017 Global and Regional Near Field Communication Chips Market Research Report Forecasts 2022

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Abstracts

This report focus on Global and regional market, providing information on major players like manufacturers, suppliers, distributors, traders, customers, investors and etc., major types, major applications from Global and major regions such as Europe, North American, South American, Asia (Excluding China), China and etc. Data type include capacity, production, market share, price, revenue, cost, gross, gross margin, growth rate, consumption, import, export and etc. Industry chain, manufacturing process, cost structure, marketing channel are also analyzed in this report.

This report provides valuable information for companies like manufacturers, suppliers, distributors, traders, customers, investors and individuals who have interests in this industry.

Major companies are as follows:

NXP Semiconductors, Broadcom Corporation, Texas Instruments Inc, Qualcomm Inc, STMicroelectronics, MediaTek Inc, Mstar Semiconductor Inc, AMS AG, Sony Corporation, Marvell technology Group,

Major types are as follows:

64 Bytes, 168 Bytes, Others

Major applications are as follows:

Consumer Electronics, Automotive, Medical

Contents

CHAPTER ONE INDUSTRY OVERVIEW

- 1.1 Definition
- 1.2 Specification
- 1.3 Classification
 - 1.3.1 64 Bytes
 - 1.3.2 168 Bytes
 - 1.3.3 Others
- 1.4 Application
 - 1.4.1 Consumer Electronics
 - 1.4.2 Automotive
 - 1.4.3 Medical

CHAPTER TWO INDUSTRY CHAIN ANALYSIS

- 2.1 Up Stream Industries Analysis
 - 2.1.1 Raw Material and Suppliers
 - 2.1.2 Equipment and Suppliers
- 2.2 Manufacturing Analysis
 - 2.2.1 Manufacturing Process
 - 2.2.2 Manufacturing Cost Structure
 - 2.2.3 Manufacturing Plants Distribution Analysis
- 2.3 Down Stream Industries Analysis

CHAPTER THREE 2011-2016 GLOBAL MARKET AND MAJOR MANUFACTURERS ANALYSIS

- 3.1 2011-2016 Global Capacity, Production, Capacity Utilization Rate, Price, Revenue, Cost, Gross and Gross Margin Analysis
- 3.2 2011-2016 Major Manufacturers Performance and Market Share

CHAPTER FOUR 2011-2016 REGIONAL MARKET AND MAJOR MANUFACTURERS ANALYSIS

- 4.1 2011-2016 Regional Market Performance and Market Share
- 4.2 Europe Market
 - 4.2.1 2011-2016 Capacity, Production, Capacity Utilization Rate, Price, Revenue,

Cost, Gross, Gross Margin Analysis

4.2.2 2011-2016 Major Manufacturers Performance and Market Share

4.2.3 2011-2016 Supply, Import, Export and Consumption Analysis

4.3 North American Market

4.3.1 2011-2016 Capacity, Production, Capacity Utilization Rate, Price, Revenue, Cost, Gross, Gross Margin Analysis

4.3.2 2011-2016 Major Manufacturers Performance and Market Share

4.3.3 2011-2016 Supply, Import, Export and Consumption Analysis

4.4 South American Market

4.4.1 2011-2016 Capacity, Production, Capacity Utilization Rate, Price, Revenue, Cost, Gross, Gross Margin Analysis

4.4.2 2011-2016 Major Manufacturers Performance and Market Share

4.4.3 2011-2016 Supply, Import, Export and Consumption Analysis

4.5 Asia (Excluding China) Market

4.5.1 2011-2016 Capacity, Production, Capacity Utilization Rate, Price, Revenue, Cost, Gross, Gross Margin Analysis

4.5.2 2011-2016 Major Manufacturers Performance and Market Share

4.5.3 2011-2016 Supply, Import, Export and Consumption Analysis

4.6 China Market

4.6.1 2011-2016 Capacity, Production, Capacity Utilization Rate, Price, Revenue, Cost, Gross, Gross Margin Analysis

4.6.2 2011-2016 Major Manufacturers Performance and Market Share

4.6.3 2011-2016 Supply, Import, Export and Consumption Analysis

4.7 ROW Market

4.7.1 2011-2016 Capacity, Production, Capacity Utilization Rate, Price, Revenue, Cost, Gross, Gross Margin Analysis

4.7.2 2011-2016 Supply, Import, Export and Consumption Analysis

CHAPTER FIVE MAJOR MANUFACTURERS ANALYSIS

5.1 NXP Semiconductors

5.1.1 Company Profile

5.1.2 Product Specification

5.1.3 2011-2016 Global Market Performance

5.1.4 Contact Information

5.2 Broadcom Corporation

5.2.1 Company Profile

5.2.2 Product Specification

5.2.3 2011-2016 Global Market Performance

- 5.2.4 Contact Information
- 5.3 Texas Instruments Inc
 - 5.3.1 Company Profile
 - 5.3.2 Product Specification
 - 5.3.3 2011-2016 Global Market Performance
 - 5.3.4 Contact Information
- 5.4 Qualcomm Inc
 - 5.4.1 Company Profile
 - 5.4.2 Product Specification
 - 5.4.3 2011-2016 Global Market Performance
 - 5.4.4 Contact Information
- 5.5 STMicroelectronics
 - 5.5.1 Company Profile
 - 5.5.2 Product Specification
 - 5.5.3 2011-2016 Global Market Performance
 - 5.5.4 Contact Information
- 5.6 MediaTek Inc
 - 5.6.1 Company Profile
 - 5.6.2 Product Specification
 - 5.6.3 2011-2016 Global Market Performance
 - 5.6.4 Contact Information
- 5.7 Mstar Semiconductor Inc
 - 5.7.1 Company Profile
 - 5.7.2 Product Specification
 - 5.7.3 2011-2016 Global Market Performance
 - 5.7.4 Contact Information
- 5.8 AMS AG
 - 5.8.1 Company Profile
 - 5.8.2 Product Specification
 - 5.8.3 2011-2016 Global Market Performance
 - 5.8.4 Contact Information
- 5.9 Sony Corporation
 - 5.9.1 Company Profile
 - 5.9.2 Product Specification
 - 5.9.3 2011-2016 Global Market Performance
 - 5.9.4 Contact Information
- 5.10 Marvell technology Group
 - 5.10.1 Company Profile
 - 5.10.2 Product Specification

5.10.3 2011-2016 Global Market Performance

5.10.4 Contact Information

5.11

5.11.1 Company Profile

5.11.2 Product Specification

5.11.3 2011-2016 Global Market Performance

5.11.4 Contact Information

5.12

5.12.1 Company Profile

5.12.2 Product Specification

5.12.3 2011-2016 Global Market Performance

5.12.4 Contact Information

5.13

5.13.1 Company Profile

5.13.2 Product Specification

5.13.3 2011-2016 Global Market Performance

5.13.4 Contact Information

5.14

5.14.1 Company Profile

5.14.2 Product Specification

5.14.3 2011-2016 Global Market Performance

5.14.4 Contact Information

5.15

5.15.1 Company Profile

5.15.2 Product Specification

5.15.3 2011-2016 Global Market Performance

5.15.4 Contact Information

5.16

5.16.1 Company Profile

5.16.2 Product Specification

5.16.3 2011-2016 Global Market Performance

5.16.4 Contact Information

5.17

5.17.1 Company Profile

5.17.2 Product Specification

5.17.3 2011-2016 Global Market Performance

5.17.4 Contact Information

5.18

5.18.1 Company Profile

- 5.18.2 Product Specification
- 5.18.3 2011-2016 Global Market Performance
- 5.18.4 Contact Information
- 5.19
 - 5.19.1 Company Profile
 - 5.19.2 Product Specification
 - 5.19.3 2011-2016 Global Market Performance
 - 5.19.4 Contact Information
- 5.20
 - 5.20.1 Company Profile
 - 5.20.2 Product Specification
 - 5.20.3 2011-2016 Global Market Performance
 - 5.20.4 Contact Information

CHAPTER SIX MAJOR CLASSIFICATION ANALYSIS

- 6.1 2011-2016 Major Classification Market Share
- 6.2 64 Bytes
- 6.3 168 Bytes
- 6.4 Others

CHAPTER SEVEN MAJOR APPLICATION ANALYSIS

- 7.1 2011-2016 Major Application Market Share
- 7.2 Consumer Electronics
 - 7.2.1 2011-2016 Consumption Analysis
 - 7.2.2 Major Down Stream Customers Analysis
- 7.3 Automotive
 - 7.3.1 2011-2016 Consumption Analysis
 - 7.3.2 Major Down Stream Customers Analysis
- 7.4 Medical
 - 7.4.1 2011-2016 Consumption Analysis
 - 7.4.2 Major Down Stream Customers Analysis

CHAPTER EIGHT GLOBAL AND REGIONAL MARKET FORECAST

- 8.1 Global Market Forecast
- 8.2 Regional Market Forecast

CHAPTER NINE MARKETING CHANNEL ANALYSIS

9.1 Marketing Channel Status

9.1.1 Direct Marketing

9.1.2 Indirect Marketing

9.1.3 Trends

9.2 Marketing Strategy

9.2.1 Pricing Strategy

9.2.2 Brand Strategy

9.2.3 Target Client

9.3 Major Distributors Analysis

CHAPTER TEN NEW PROJECT INVESTMENT FEASIBILITY ANALYSIS

10.1 New Project SWOT Analysis

10.2 New Project Investment Feasibility Analysis

CHAPTER ELEVEN CONCLUSIONS

Research Methodology

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